



4th November, 2025

To,
National Stock Exchange of India Limited
Exchange Plaza, 5th Floor,
Plot No. C/1, G Block,
Bandra - Kurla Complex, Bandra (E),
Mumbai - 400051.

SCRIP Code/ISIN : **HPTL / INE0VA601019**
Subject : **Execution of Loan Agreement**
Reference : **Regulation 30 of SEBI (Listing Obligations and Disclosure Requirements) Regulations, 2015**

Dear Sir/Madam,

Pursuant to Regulation 30 of Securities and Exchange Board of India (Listing Obligations and Disclosure Requirements) Regulations, 2015, we hereby inform the Stock Exchange that the Board of Directors have approved execution of Loan agreement with M/s. Kabir Technologies Private Limited.

The details required under Regulation 30 Read with Schedule III of the SEBI (LODR) Regulations, 2015 along with relevant SEBI Circular, is enclosed herewith as **Annexure I**.

The meeting of the Board of Directors of the Company was held today i.e., Tuesday, the 4th November 2025 at 03.00 p.m. and concluded at 04.15 p.m.

Kindly take the same on your record and oblige.

Thanking you,

Yours faithfully,
For HP TELECOM INDIA LIMITED

KHUSHBOO MODI
Company Secretary and Compliance Officer
ACS No.: 57323

Encl: As above

HP TELECOM INDIA LIMITED

Registered Address: Plot No - 97, 1st Floor, Om Square, Near Ishwar Farm, BRTS Canal Road, Bhatar, Althan, Surat, Gujarat, India, 395017
CIN: L51395GJ2011PLC064616 **Ph:** 93274 81169 **E-mail:** cs@hvcipl.com **Website:** www.hptil.com

Annexure I

Details required under Regulation 30 of Listing Regulations read along with relevant SEBI Circulars

S. N.	Required details	Particulars
1	Name of the parties with whom the agreement is entered.	M/s. Kabir Technologies Private Limited
2	Purpose of entering into the agreement.	Inter corporate loan
3	Size of agreement.	Rs. 10 Crore (Rupees Ten Crore Only)
4	Shareholding, if any, in the entity with whom the agreement is executed.	None. The buyer is not related to the Company.
5	Significant terms of the agreement (in brief) special rights like right to appoint directors, first right to share subscription in case of issuance of shares, right to restrict any change in capital structure etc.	None.
6	Whether the said parties are related to promoter/ promoter group/ group companies in any manner. If yes, nature of relationship.	No.
7	Whether the transaction would fall within related party transactions? If yes, whether the same is done at "arm's length.	No.
8	In case of issuance of shares to the parties, details of issue price, class of shares issued.	Not applicable.
9	In case of loan agreements, details of lender/ borrower, nature of the loan, total amount of loan granted/ taken, total amount outstanding, date of execution of the loan agreement/sanction letter, details of the security provided to the lenders/ by the borrowers for such loan or in case outstanding loans lent to a party or borrowed from a party become material on a cumulative basis.	• Lender: M/s. HP Telecom India Limited • Borrower: M/s. Kabir Technologies Private Limited • Nature of Loan: Inter Corporate Loan • Amount of loan granted: Rs. 10 Crore. (Rupees Ten Crores Only) at the rate of 15% p.a. • Date of execution of loan agreement: November 04, 2025. • Details of security provided by the borrower: Unsecured loan • Amount of loan outstanding as on date of disclosure: Nil
10	Any other disclosures related to such agreements, viz., details of nominee on the board of directors of the listed entity, potential conflict of interest arising out of such agreements, etc.	Not applicable.
11	In case of termination or amendment of agreement, listed entity shall disclose additional details to the stock exchange(s): - name of parties to the agreement; - nature of the agreement; - date of execution of the agreement; - details of amendment and impact thereof or reasons of termination and impact thereof.	Not applicable.

HP TELECOM INDIA LIMITED

Registered Address: Plot No - 97, 1st Floor, Om Square, Near Ishwar Farm, BRTS Canal Road, Bhatar, Althan, Surat, Gujarat, India, 395017

CIN: L51395GJ2011PLC064616 **Ph:** 93274 81169 **E-mail:** cs@hvciipl.com **Website:** www.hptil.com